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10-bit level-shifting bus switch with output enable

Rev. 4 — 14 December 2011

Product data sheet

1. General description

The 74CBTLVD3861 is a 10-bit 3.3 V to 1.8 V level translating bus switch with one output enable (\overline{OE}) input. When \overline{OE} is LOW, the switch is closed and port A is connected to the B port. When \overline{OE} is HIGH, the switch is disabled.

To ensure the high-impedance OFF-state during power-up or power-down, \overline{OE} should be tied to the V_{CC} through a pull-up resistor. The minimum value of the resistor is determined by the current-sinking capability of the driver.

Schmitt trigger action at control input makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 3.0 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}.

2. Features and benefits

- Supply voltage range from 3.0 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-B/JESD36 (3.0 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- 4 Ω switch connection between two ports
- 3.3 V to 1.8 V level translation
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



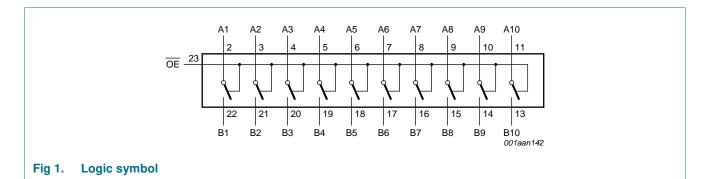
10-bit level-shifting bus switch with output enable

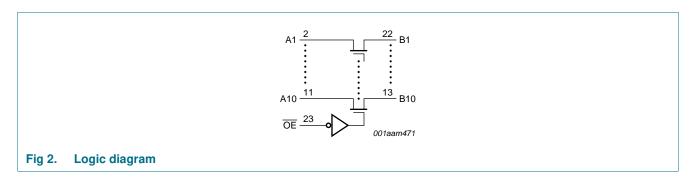
3. Ordering information

Table 1. Ordering	information			
Type number	Package			
	Temperature range	Name	Description	Version
74CBTLVD3861DK	-40 °C to +125 °C	SSOP24 ^[1]	plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT556-1
74CBTLVD3861PW	-40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1
74CBTLVD3861BQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm	SOT815-1

[1] Also known as QSOP24 package

4. Functional diagram

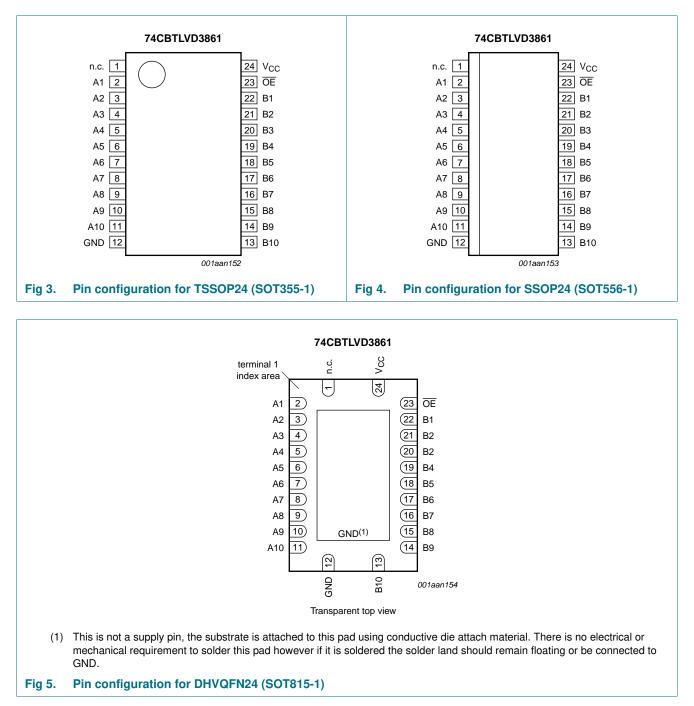




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5. Pinning information

5.1 Pinning



10-bit level-shifting bus switch with output enable

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
nc	1	not connected
A1 to A10	2, 3, 4, 5, 6, 7, 8, 9, 10, 11	data input/output (A port)
GND	12	ground (0 V)
B1 to B10	22, 21, 20, 19, 18, 17, 16,	15, 14, 13 data input/output (B port)
OE	23	output enable input (active LOW)
V _{CC}	24	positive supply voltage

6. Functional description

Table 3. Function selection^[1]

Input OE	Input/output
OE	An, Bn
L	An = Bn
Н	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage		[1] -0.5	+4.6	V
V _{SW}	switch voltage	enable and disable mode	[1] -0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	V _I < -0.5 V	-50	-	mA
I _{SK}	switch clamping current	$V_{1} < -0.5 V$	-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SSOP24 and TSSOP24 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C. For DHVQFN24 package: P_{tot} derates linearly at 4.5 mW/K above 60 °C.

10-bit level-shifting bus switch with output enable

8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		3.0	3.6	V
VI	input voltage		0	3.6	V
V _{SW}	switch voltage	enable and disable mode	0	V_{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[1]</u> _	200	ns/V

[1] Applies to control signal levels.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

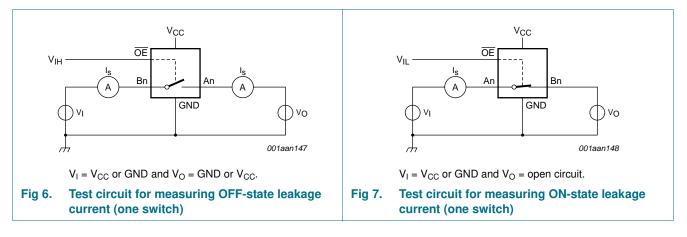
Symbol	Parameter	Conditions		ıb = -	-40 °C to -	-85 °C	T _{amb} = -40 °C	Unit	
			Mi	in	Typ <mark>[1]</mark>	Мах	Min	Max	
V _{IH}	HIGH-level input voltage	$V_{CC} = 3.0 V \text{ to } 3.6 V$	2.	0	-	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 3.0 V to 3.6 V	-		-	0.9	-	0.9	V
lı	input leakage current	pin \overline{OE} ; V _I = GND to V _{CC} ; V _{CC} = 3.6 V	-		-	±1	-	±20	μA
V _{pass}	pass voltage	$V_I = V_{CC}$; see <u>Figure 8</u> to <u>Figure 12</u>	-		-	-	-	-	V
$I_{S(OFF)}$	OFF-state leakage current	$V_{CC} = 3.6 V$; see Figure 6	-		-	±1	-	±20	μA
I _{S(ON)}	ON-state leakage current	$V_{CC} = 3.6 V$; see Figure 7	-		-	±1	-	±20	μA
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-		-	±10	-	±50	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC}; I_{O} = 0 \; A; V_{CC} = 3.6 \; V; \\ V_{SW} = GND \; or \; V_{CC} \end{array}$	-		-	20	-	50	μA
			-		-	100	-	150	μA
∆l _{CC}	additional supply current	$ \begin{array}{l} \mbox{pin } \overline{OE}; \ \mbox{V}_{1} = \ \mbox{V}_{CC} - 0.6 \ \mbox{V}; \\ \ \mbox{V}_{SW} = \ \mbox{GND or } \ \mbox{V}_{CC}; \\ \ \mbox{V}_{CC} = 3.6 \ \mbox{V} \end{array} $	[2] _		-	300	-	2000	μA
CI	input capacitance	pin \overline{OE} ; V _{CC} = 3.3 V; V _I = 0 V to 3.3 V	-		0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-		2.5	-	-	-	pF
C _{S(ON)}	ON-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-		9.0	-	-	-	pF

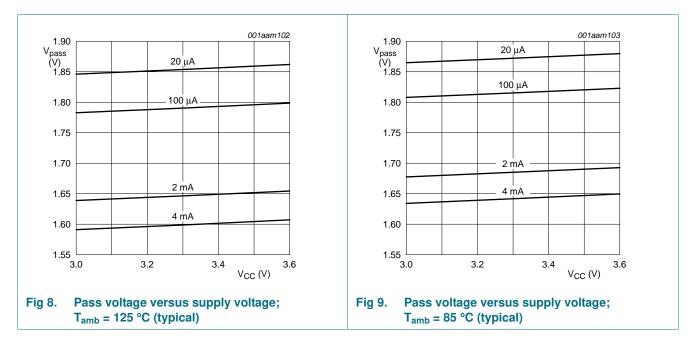
[1] All typical values are measured at $T_{amb} = 25$ °C.

[2] One input at 3 V, other inputs at V_{CC} or GND.

10-bit level-shifting bus switch with output enable

9.1 Test circuits

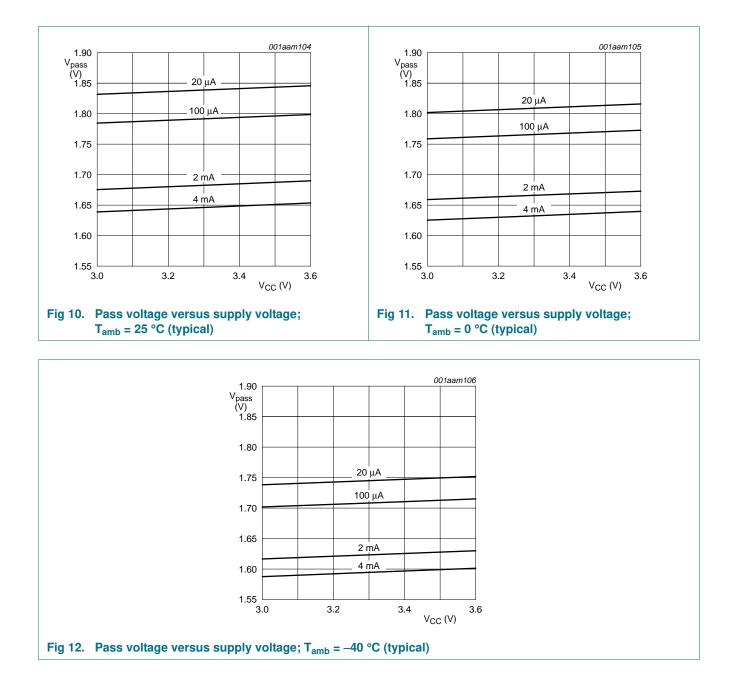




9.2 Typical pass voltage graphs

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9.3 ON resistance

Table 7. Resistance R_{ON}

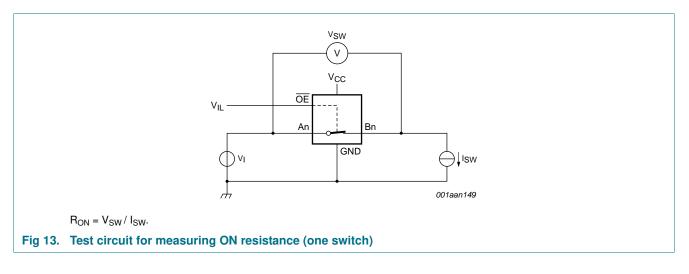
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

Symbol	Parameter	Conditions	T _{amb} = -40 °C to +85 °C			T _{amb} = -40 °	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R _{ON}	ON resistance	$V_{\rm CC} = 3.0 \text{ V to } 3.6 \text{ V}$ [2]						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		I _{SW} = 15 mA; V _I = 1.2 V	-	4.7	10.0	-	12.0	Ω

[1] Typical values are measured at T_{amb} = 25 °C and nominal $V_{CC}.$

[2] Measured by the voltage drop between the An and Bn terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (An or Bn) terminals.

9.4 ON resistance test circuit



10-bit level-shifting bus switch with output enable

10. Dynamic characteristics

Dynamic characteristics Table 8.

GND = 0 V; for test circuit see Figure 16

Symbol	Parameter	Conditions	Conditions T		_{mb} = -40 °C to +85 °C		T_{amb} = -40 °	C to +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	An to Bn or Bn to An; see <u>Figure 14</u>	<u>[2][3]</u>						
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	-	0.11	-	0.22	ns
t _{en}	enable time	OE to An or Bn; see <u>Figure 15</u>	<u>[4]</u>						
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V		1.5	2.9	5.0	1.5	6.0	ns
t _{dis}	disable time	OE to An or Bn; see <u>Figure 15</u>	<u>[5]</u>						
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V		0.8	3.3	7.0	0.8	8.0	ns

[1] All typical values are measured at T_{amb} = 25 °C and at nominal V_{CC}.

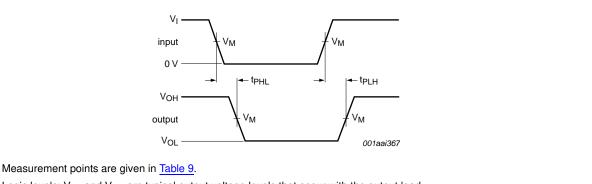
[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

 t_{pd} is the same as t_{PLH} and t_{PHL} . [3]

[4] t_{en} is the same as t_{PZH} and t_{PZL} .

[5] t_{dis} is the same as t_{PHZ} and t_{PLZ}.

10.1 Waveforms



Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 14. The data input (An, Bn) to output (Bn, An) propagation delay times

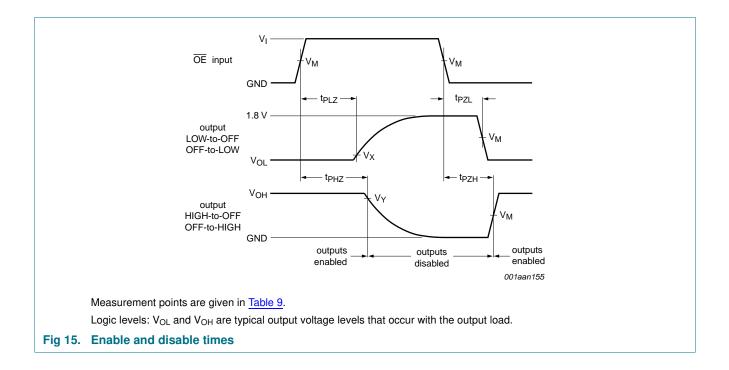
Table 9. **Measurement points**

Supply voltage	Input			Output		
V _{cc}	V _M	VI	$t_r = t_f$	V _M	V _X	V _Y
3.0 V to 3.6 V	0.5V _{CC}	V _{CC}	\leq 2.0 ns	0.9 V	V _{OL} + 0.15 V	$V_{OH} - 0.15 V$

74CBTLVD3861 Product data sheet

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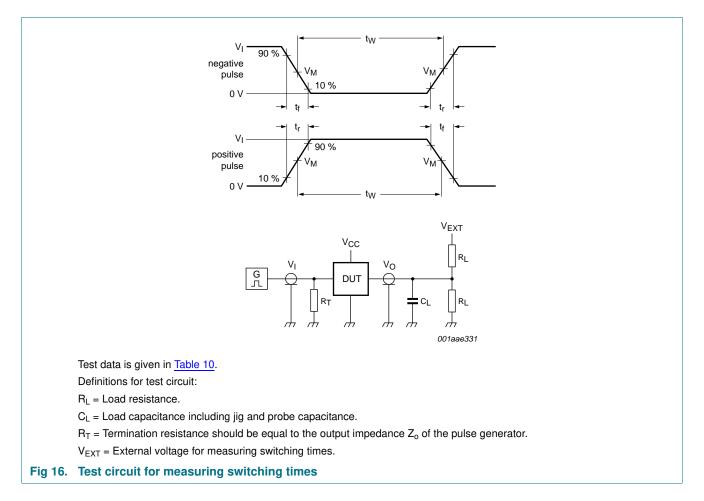


Table 10. Test data

Supply voltage	Load		V _{EXT}		
V _{cc}	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
3.0 V to 3.6 V	30 pF	1 kΩ	open	GND	3.6 V

10-bit level-shifting bus switch with output enable

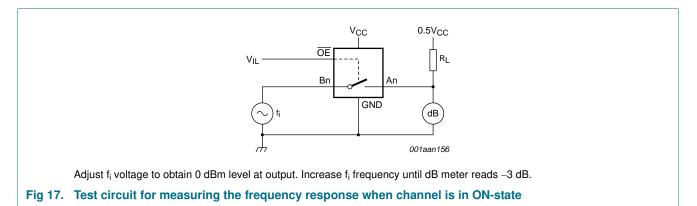
10.2 Additional dynamic characteristics

Table 11.Additional dynamic characteristicsGND = 0 V.

Symbol	Parameter	Conditions		Tar	_{nb} = 25	°C	Unit
				Min	Тур	Max	
$f_{(-3dB)}$	-3 dB frequency response	V_{CC} = 3.3 V; R_L = 50 Ω ; see Figure 17	<u>[1]</u>	-	575	-	MHz

[1] f_i is biased at 0.5V_{CC}.

10.3 Test circuit



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10-bit level-shifting bus switch with output enable

11. Package outline

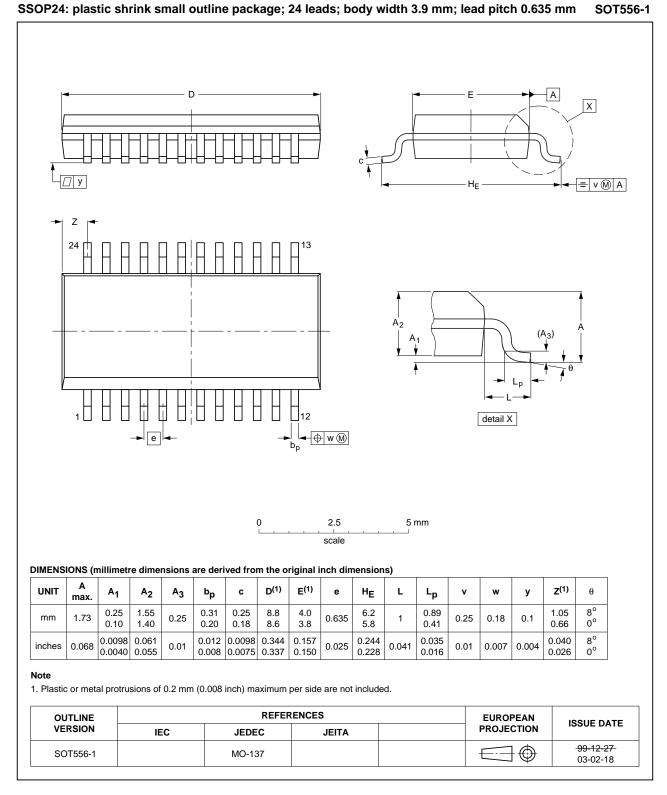


Fig 18. Package outline SOT556-1 (SSOP24)

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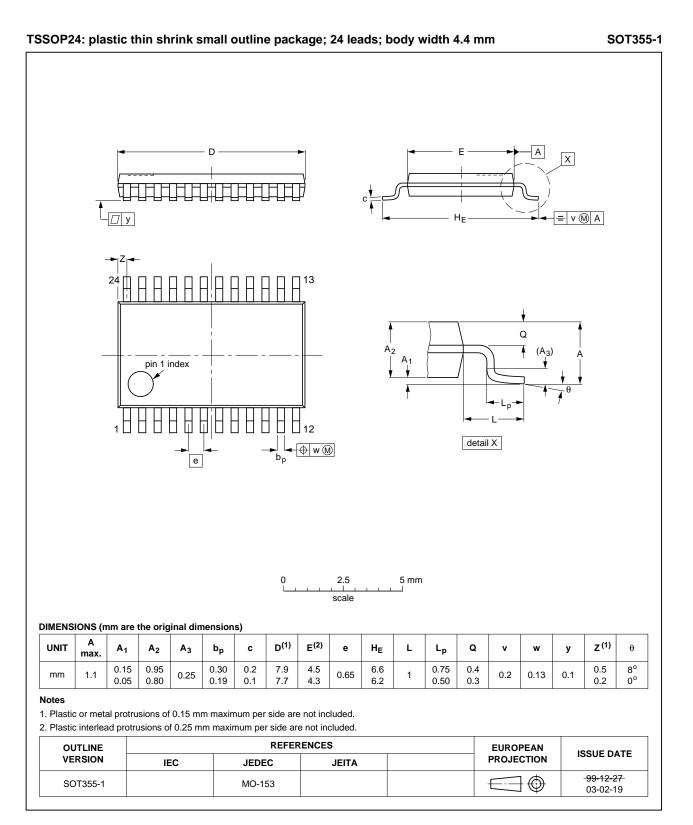
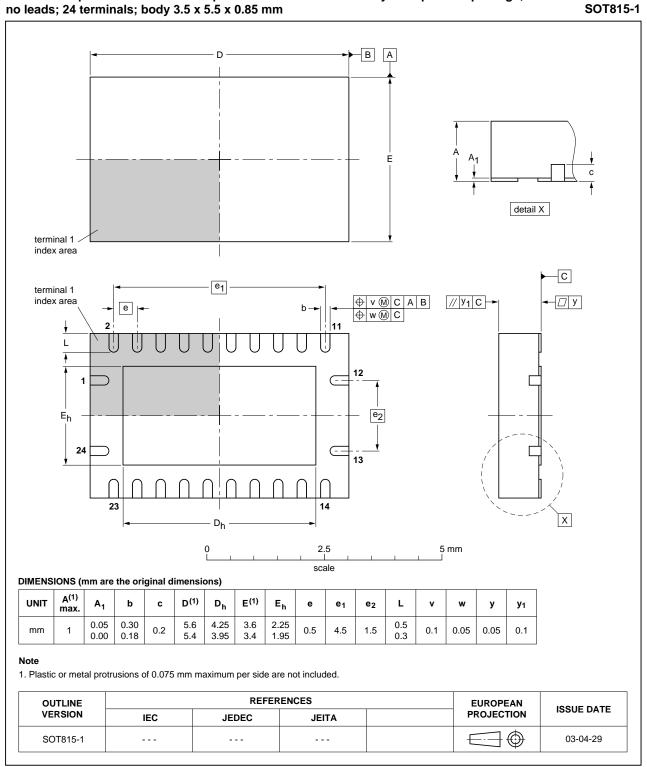


Fig 19. Package outline SOT355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 20. Package outline SOT815-1 (DHVQFN24)

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10-bit level-shifting bus switch with output enable

12. Abbreviations

	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

13. Revision history

Table 13.Revision history

Change notice	Supersedes
	•
-	74CBTLVD3861 v.3
-	74CBTLVD3861 v.2
-	74CBTLVD3861 v.1
-	-
	-

10-bit level-shifting bus switch with output enable

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